

Surface Mount Superfast Recovery Rectifier

FEATURES:

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

Circuit Diagram & Pin Configuration:



SMBF

Marking

| Type number | Marking code |
|-------------|--------------|
| ES2ABF | E2AB |
| ES2BBF | E2BB |
| ES2CBF | E2CB |
| ES2DBF | E2DB |
| ES2EBF | E2EB |
| ES2GBF | E2GB |
| ES2JBF | E2JB |

Absolute Maximum Ratings and Characteristics

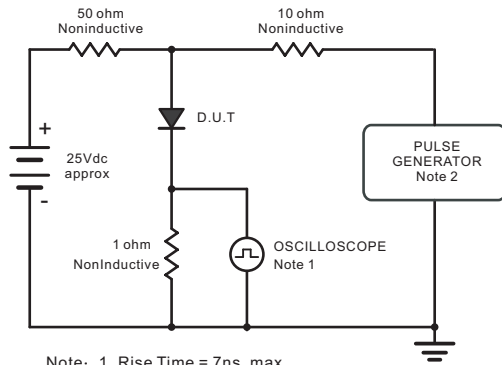
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Parameter | Symbols | ES2ABF | ES2BBF | ES2CBF | ES2DBF | ES2EBF | ES2GBF | ES2JBF | Units |
|--|--------------------------------------|------------|--------|--------|--------|--------|--------|--------|-------|
| Maximum Repetitive Peak Reverse Voltage | V _{RRM} | 50 | 100 | 150 | 200 | 300 | 400 | 600 | V |
| Maximum RMS voltage | V _{RMS} | 35 | 70 | 105 | 140 | 210 | 280 | 420 | V |
| Maximum DC Blocking Voltage | V _{DC} | 50 | 100 | 150 | 200 | 300 | 400 | 600 | V |
| Maximum Average Forward Rectified Current at T _c = 125 °C | I _{F(AV)} | 2 | | | | | | | A |
| Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load | I _{FSM} | 50 | | | | | | | A |
| Maximum Forward Voltage at 2 A | V _F | 1 | | | | 1.25 | | 1.68 | V |
| Maximum DC Reverse Current T _a = 25 °C at Rated DC Blocking Voltage T _a =125 °C | I _R | 5 100 | | | | | | | μA |
| Typical Junction Capacitance at V _R =4V, f=1MHz | C _j | 28 | | | | | | | pF |
| Maximum Reverse Recovery Time ⁽¹⁾ | t _{rr} | 35 | | | | | | | ns |
| Typical Thermal Resistance ⁽²⁾ | R _{θJA} R _{θJC} | 60 18 | | | | | | | °C/W |
| Operating and Storage Temperature Range | T _j , T _{stg} | -55 ~ +150 | | | | | | | °C |

(1) Measured with $I_F = 0.5\text{ A}$, $I_R = 1\text{ A}$, $I_{rr} = 0.25\text{ A}$.

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



Note: 1. Rise Time = 7ns, max.
Input Impedance = 1megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.

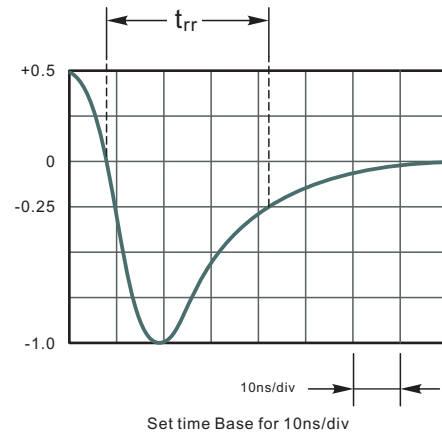


Fig.2 Maximum Average Forward Current Rating

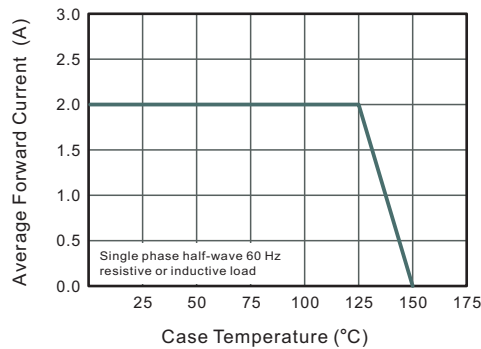


Fig.3 Typical Reverse Characteristics

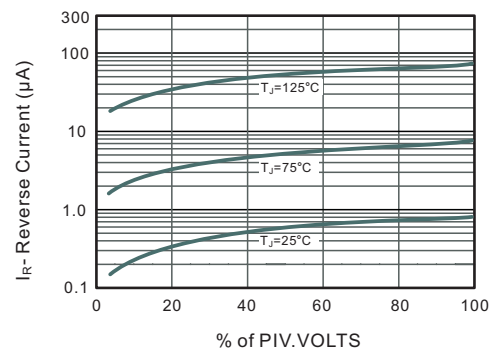


Fig.4 Typical Forward Characteristics

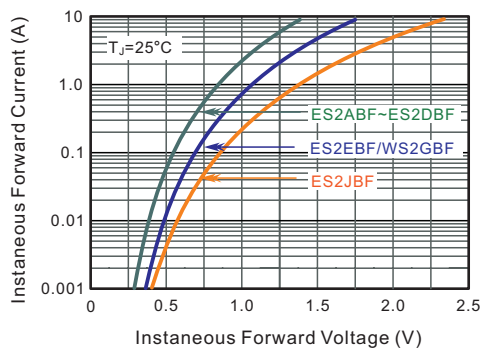


Fig.5 Typical Junction Capacitance

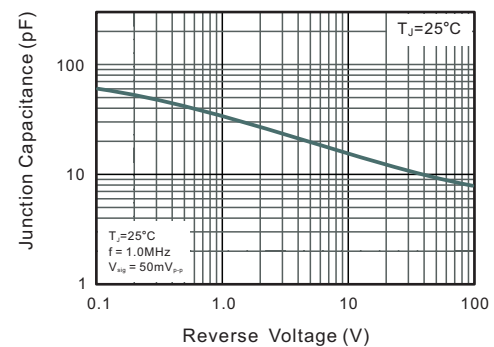
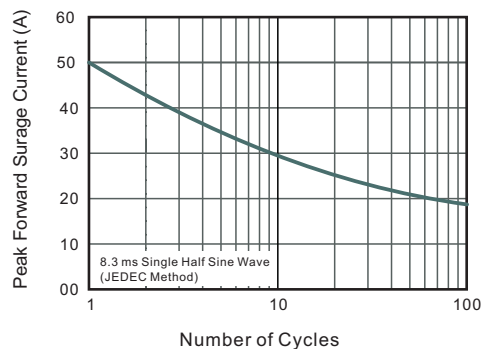


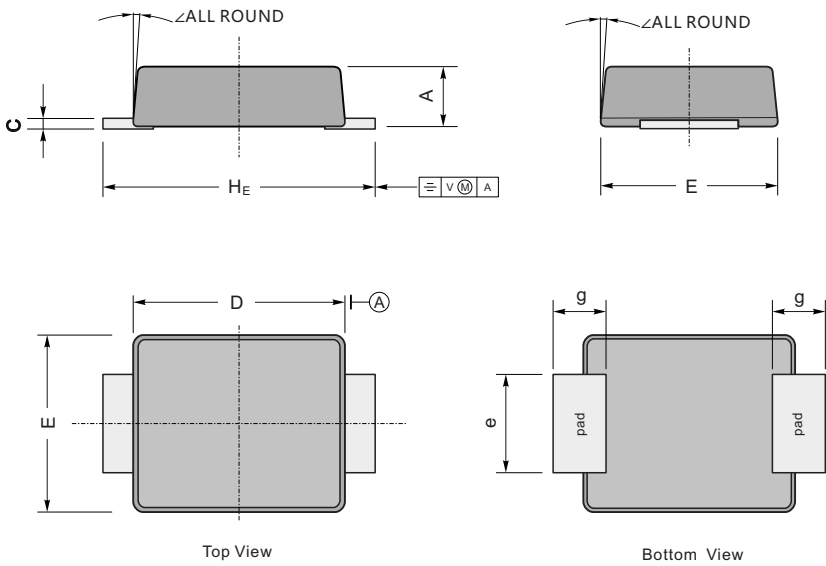
Fig.6 Maximum Non-Repetitive Peak Forward Surge Current



PACKAGE OUTLINE

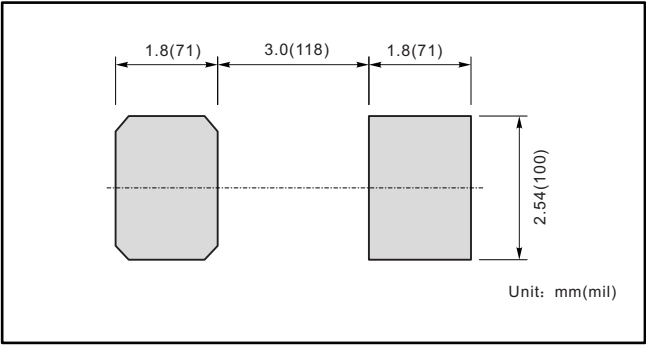
Plastic surface mounted package; 2 leads

SMBF



| UNIT | | A | C | D | E | H _E | e | g | ∠ |
|------|-----|-----|------|-----|-----|----------------|-----|-----|----|
| mm | max | 1.3 | 0.26 | 4.4 | 3.7 | 5.5 | 2.2 | 1.0 | 9° |
| | min | 1.1 | 0.18 | 4.2 | 3.5 | 5.1 | 1.9 | | |
| mil | max | 51 | 10 | 173 | 146 | 216 | 86 | 40 | |
| | min | 43 | 7 | 165 | 138 | 200 | 75 | | |

The recommended mounting pad size



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